

TDA7263

12 +12W STEREO AMPLIFIER WITH MUTING

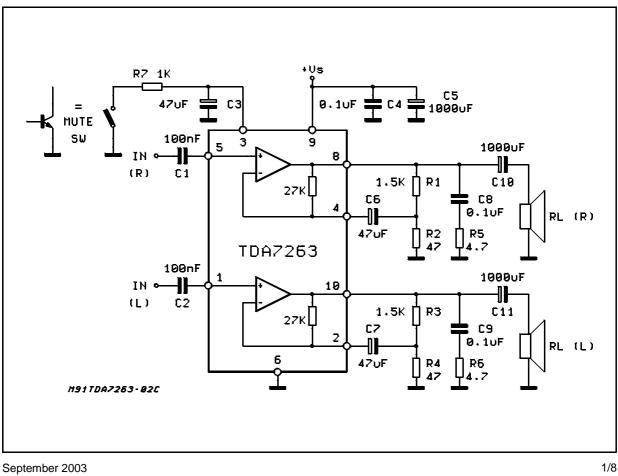
- WIDE SUPPLY VOLTAGE RANGE
- HIGH OUTPUT POWER
 12+12W @ V_S=28V, R_L = 8Ω, THD=10%
- MUTE FACILITY (POP FREE) WITH LOW CONSUMPTION
- AC SHORT CIRCUIT PROTECTION
- THERMAL OVERLOAD PROTECTION



DESCRIPTION

The TDA7263 is class AB dual audio power amplifier assembled in the new Clipwatt package, specially designed for high quality sound application as HI-FI music centers and stereo TV sets.

TEST AND APPLICATION CIRCUIT

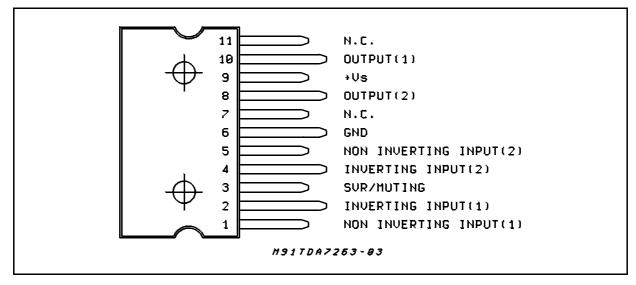


TDA7263

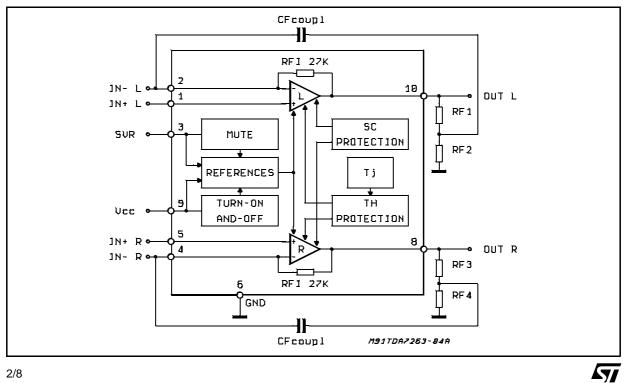
ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
Vs	Supply Voltage without Load	35	V
lo	Output Peak Current (repetitive f >20Hz)	2	А
P _{tot}	Total Power Dissipation (T _{case} = 70°C)	25	W
T _{op}	Operating Temperature Range	0 to 70	°C
T _{stg,Tj}	Storage & Junction Temperature	-40 to 150	°C

PIN CONNECTION (Top view)



BLOCK DIAGRAM



THERMAL DATA

Symbol	Parameter	Value	Unit
R _{th j-case}	Thermal resistance junction to case Max	3	°C/W

ELECTRICAL CHARACTERISTICS (Refer to the stereo test and application circuit, $V_S = 28V$; $R_L = 8_{\Omega}$; $G_v = 30dB$; f = 1KHz; $T_{amb} = 25^{\circ}C$ unless otherwise specified.)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
Vs	Supply Voltage		10		30	V
Vo	Quiescent Output Voltage			13.5		V
lq	Total Quiescent Current			70	95	mA
Po	Output Power (RMS)	d = 10% Tamb = 85°C d = 1%	10	12 9.5		W W
d	Total Harmonic Distortion	$P_{O} = 1W$, f = 1kHz f = 100Hz to 10KHz; $P_{O} = 0.1$ to 8W		0.02	0.2 0.5	%
СТ	Cross Talk	$R_S = 10K\Omega; f = 1KHz$		70		dB
		$R_S = 10K\Omega; f = 10KHz$		60		dB
Rı	Input Resistance		100	200		KΩ
fL	Low Frequency Roll-off (-3dB)			40		Hz
f _H	High Frequency Roll-off (-3dB)			80		KHz
en	Total Input Noise Voltage	A Curve; Rs = 10KΩ		1.5		mV
		f = 22Hz to 22KHz; Rs = $10K\Omega$		3	10	μV
SVR	Supply Voltage Rejection (each channel)	$R_{S}=10K\Omega;\ f=100Hz;\ Vr=0.5V$	45	60		dB
Tj	Thermal Shutdown Junction Temperature			145		°C
MUTE FUN	CTION					
VT _{MUTE}	Mute Threshold		1	1.6		V
VT _{PLAY}	Play Threshold			4.5		V
ATT _{AM}	Mute Attenuation		70	100		dB
I _{qMUTE}	Quiescent Current @ Mute			7	10	mA

TYPICAL CHARACTERISTICS (referred to the typical Application Circuit, $V_S = 28V$, $R_L = 8\Omega$, unless otherwise specified)



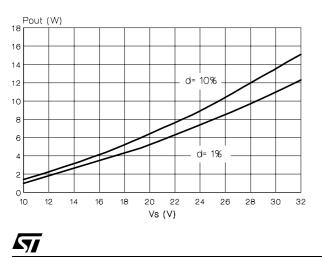
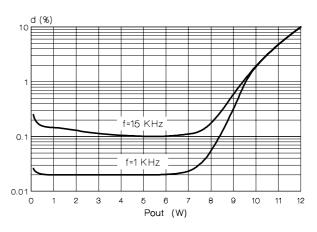


Figure 2: Distortion vs. Output Power



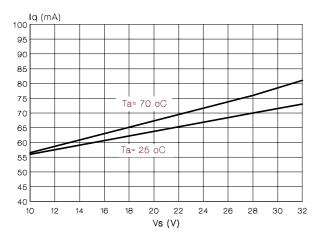


Figure 3: Quiescent Current vs. Supply Voltage

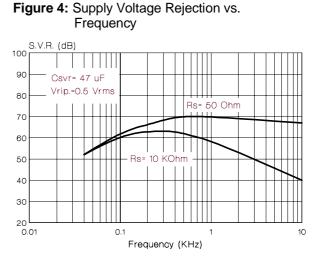


Figure 5: Crosstalk vs. Frequency

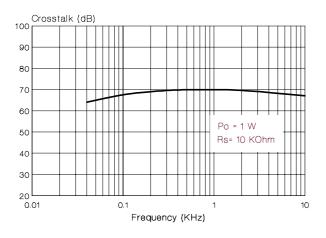


Figure 7: Total Power Dissipation vs. Output Power

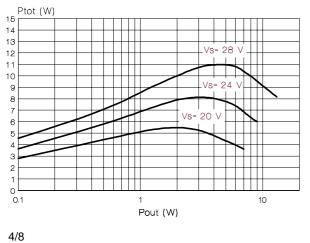


Figure 6: Output Attenuation & Quiescent Current vs. V_{pin3}

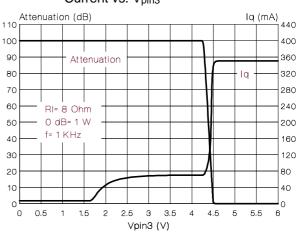
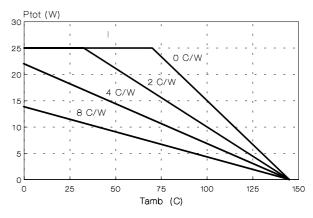


Figure 8: Maximum allowable Power dissipation vs. Ambient Temperature



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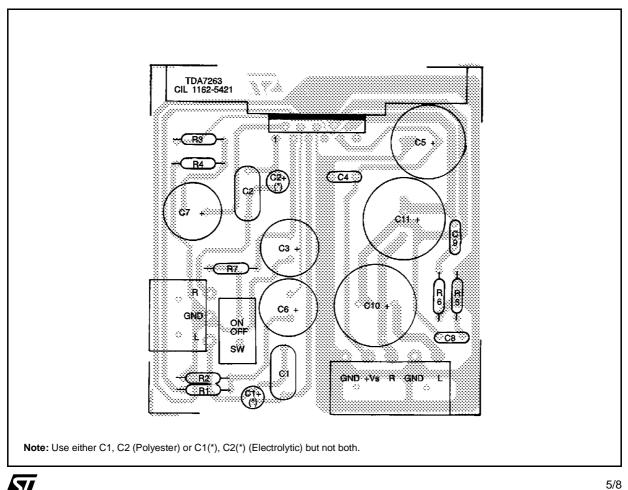
APPLICATION SUGGESTION

The recommended values of the components are those shown on the typical application circuit. Different values can be used; the following table can help the designer.

Component	Recomm. Value	Purpose	Larger Than	Smaller Than
R1 and R3	1.5KΩ	Close loop gain setting (*)	Increase of gain	Decrease of gain
R2 and R4	47Ω	Close loop gain setting (*)	Decrease of gain	Increase of gain
R5 and R6	4.7Ω	Frequency stability	Danger of oscillations	
C1 and C2	100nF	Input DC decoupling	Higher SVR	Higher low frequency cutoff
C3	47μF	 Ripple Rejection Mute time constant 	Increase of the Switch-on time	- Degradation of SVR - Worse tum-off pop by muting
C4	100nF	Supply Voltage Bypass		Danger of oscillations
C5	1000μF	Supply Voltage Bypass		
C6 and C7	47μF	Feedback input DC decoupling	Increase of the Switch-on time	Danger of Switch-on time
C8 and C9	0.1µF	Frequency stability		Danger of oscillations
C10 and C11	1000µF	Output DC decoupling		Higher low-frequency cut-off

(*) Closed loop gain must be higher than 26dB

Figure 9: P.C. Board and Component Layout (1:1 scale)



BUILT-IN PROTECTION SYSTEMS

THERMAL SHUT-DOWN

The presence of a thermal limiting circuit offers the following advantages:

- 1-an overload on the output (even if it is permanent), or an excessive ambient temperature can be easily withstood.
- 2-the heatsink can have a smaller factor of safety compared with that of a conventional circuit. There is no device damage in the case of excessive junction temperature; if for any reason the junction temperature increases up to 145°C. the thermal shutdown simply re-

duces the output power and therefore the power dissipation.

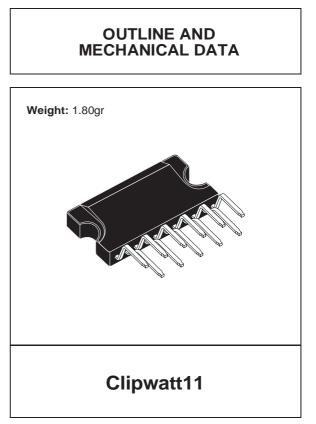
The maximum allowable power dissipation depends upon the thermal resistance junction-ambient. Figure 8 shows the dissipable power as a function of ambient temperature for different heatsink thermal resistance.

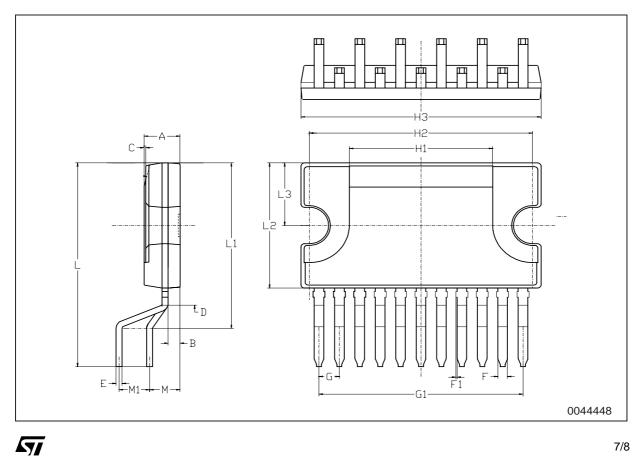
SHORT CIRCUIT (AC CONDITIONS)

The TDA7263 can withstand accidental short circuits across the speaker made by a wrong connection during normal play operation.

TDA7263

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А			3.2			0.126
В			1.05			0.041
С		0.15			0.006	
D		1.5			0.059	
Е	0.49		0.55	0.019		0.002
F	0.77	0.8	0.88	0.030	0.031	0.035
F1			0.15			0.006
G	1.57	1.7	1.83	0.062	0.067	0.072
G1	16.87	17	17.13	0.664	0.669	0.674
H1		12			0.480	
H2		18.6			0.732	
H3	19.85			0.781		
L		17.9			0.700	
L1		14.55			0.580	
L2	10.7	11	11.2	0.421	0.433	0.441
L3		5.5			0.217	
М		2.54			0.100	
M1		2.54			0.100	





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